INTEGRATED CIRCUITS

DATA SHEET

74ALVCH16827

20-bit buffer/line driver, non-inverting (3-State)

Product specification

1998 Jul 27

IC24 Data Handbook





20-bit buffer/line driver, non-inverting (3-State)

74ALVCH16827

FEATURES

- Wide supply voltage range of 1.2V to 3.6V
- Complies with JEDEC standard no. 8-1A
- Wide supply voltage range of 1.2V to 3.6V
- CMOS low power consumption
- Direct interface with TTL levels
- Universal bus transceiver with D-type latches and D-type flip-flops capable of operating in transparent, latched, clocked or clocked-enabled mode.
- MULTIBYTETM flow-through standard pin-out architecture
- Low inductance multiple V_{CC} and GND pins for minimum noise and ground bounce
- Current drive ±24 mA at 3.0 V
- All inputs have bus hold circuitry
- Output drive capability 50Ω transmission lines @ 85°C
- 3-State non-inverting outputs for bus oriented applications

DESCRIPTION

The 74ALVCH16827 is a 20-bit non-inverting buffer/driver with 3-State outputs for bus oriented applications.

The 74ALVCH16827 consists of two 10-bit sections with separate output enable signals. For either 10-bit buffer section, the two output enable (10E1 and 10E2 or 20E1 and 20E2) inputs must both be active. If either output enable input is high, the outputs of that 10-bit buffer section are in high impedance state.

The 74ALVCH16827 has active bus hold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

QUICK REFERENCE DATA

GND = 0V; $T_{amb} = 25^{\circ}C$; $t_r = t_f = 2.5$ ns

SYMBOL	PARAMETER	CONDITION	NS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay CP to Qn	$V_{CC} = 2.5V, C_L = 30pF$ $V_{CC} = 3.3V, C_L = 50pF$		2.0 2.0	ns
C _I	Input capacitance			5	pF
C _{PD}	Power dissipation capacitance per latch	$V_1 = GND \text{ to } V_{CC}^{-1}$	Output enabled	20	PF
OPD	ower dissipation capacitance per laten	1 - 214D 10 AGG	Output disabled	3	Pi

NOTES:

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
56-Pin Plastic TSSOP Type II	-40°C to +85°C	74ALVCH16827 DGG	ACH16827 DGG	SOT364-1

PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
55, 54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31, 30	1A0 - 1A9 2A0 - 2A9	Data inputs
2, 3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26, 27	1Y0 - 1Y9 2Y0 - 2Y9	Data outputs
1, 56, 28, 29	1 <u>0</u> E0, 1 <u>0</u> E1 20E0, 20E1	Output enable inputs (active-Low)
4, 11, 18, 25, 32, 39, 46, 53	GND	Ground (0V)
7, 22, 35, 50	V _{CC}	Positive supply voltage

^{1.} C_{PD} is used to determine the dynamic power dissipation (P_D in μ W): $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; C_L = output load capacity in pF;

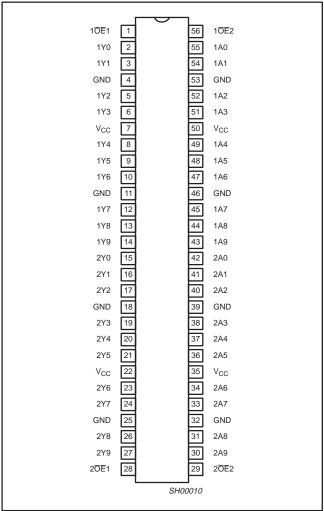
 f_o = output frequency in MHz; V_{CC} = supply voltage in V;

 $[\]Sigma (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$

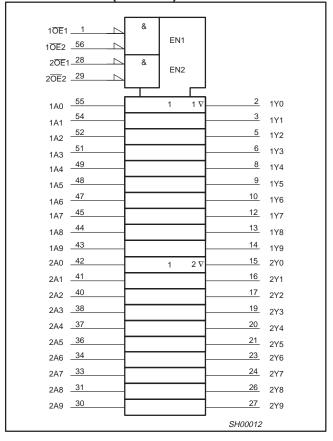
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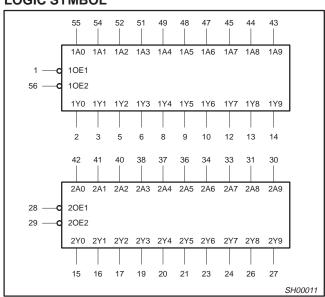
PIN CONFIGURATION



LOGIC SYMBOL (IEEE/IEC)



LOGIC SYMBOL



FUNCTION TABLE

	INPUTS	OUTPUTS	
n OE 1	n OE 2	Α	Υ
L	L	L	L
L	L	Н	Н
Н	Н	Х	Z
Х	Н	X	Z

High voltage level Low voltage level

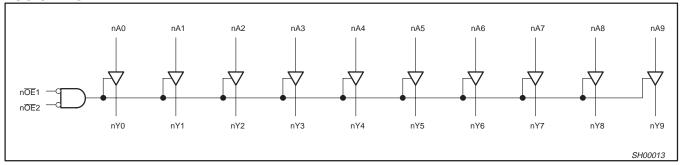
Don't care

High impedance "off" state

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LOGIC DIAGRAM



RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V	DC supply voltage 2.5V range (for max. speed performance @ 30 pF output load)		2.3	2.7	V
Vcc	DC supply voltage 3.3V range (for max. speed performance @ 50 pF output load)		3.0	3.6	V
VI	DC Input voltage range		0	V _{CC}	V
V _O	DC output voltage range		0	V _{CC}	V
T _{amb}	Operating free-air temperature range		-40	+85	°C
t _r , t _f	Input rise and fall times	$V_{CC} = 2.3 \text{ to } 3.0 \text{V}$ $V_{CC} = 3.0 \text{ to } 3.6 \text{V}$	0 0	20 10	ns/V

ABSOLUTE MAXIMUM RATINGS¹

In accordance with the Absolute Maximum Rating System (IEC 134) Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
I _{IK}	DC input diode current	V _I < 0	-50	mA
V _I	DC input voltage	For control pins ²	-0.5 to +4.6	V
"	De input voltage	For data inputs ²	–0.5 to V _{CC} +0.5	ľ
I _{OK}	DC output diode current	$V_O > V_{CC}$ or $V_O < 0$	±50	mA
Vo	DC output voltage	Note 2	–0.5 to V _{CC} +0.5	V
Io	DC output source or sink current	$V_O = 0$ to V_{CC}	±50	mA
I _{GND} , I _{CC}	DC V _{CC} or GND current		±100	mA
T _{stg}	Storage temperature range		-65 to +150	°C
Ртот	Power dissipation per package -plastic medium-shrink (SSOP) -plastic thin-medium-shrink (TSSOP)	For temperature range: -40 to +125 °C above +55°C derate linearly with 11.3 mW/K above +55°C derate linearly with 8 mW/K	850 600	mW

NOTE

^{1.} Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltage are referenced to GND (ground = 0 V).

				LIMITS		
SYMBOL	PARAMETER	TEST CONDITIONS	Temp :	= -40°C to +8	5°C	UNIT
			MIN	TYP ¹	MAX	1
.,		V _{CC} = 2.3 to 2.7V	1.7	1.2		,,
V_{IH}	HIGH level Input voltage	V _{CC} = 2.7 to 3.6V	2.0	1.5		\ \
.,	1000	V _{CC} = 2.3 to 2.7V		1.2	0.7	,,
V_{IL}	LOW level Input voltage	V _{CC} = 2.7 to 3.6V		1.5	0.8	\ \
		$V_{CC} = 2.3 \text{ to } 3.6 \text{V}; V_{I} = V_{IH} \text{ or } V_{IL}; I_{O} = -100 \mu\text{A}$	V _{CC} -0.2	V _{CC}		
		$V_{CC} = 2.3V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -6$ mA	V _{CC} - 0.3	V _{CC} -0.08		1
	LUCII I saad sadaad aadka sa	$V_{CC} = 2.3V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -12mA$	V _{CC} - 0.6	V _{CC} - 0.26		1 ,,
V _{OH}	HIGH level output voltage	$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -12mA$	V _{CC} - 0.5	V _{CC} -0.14		\ \
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -12$ mA		V _{CC} - 0.09		1
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -24$ mA	V _{CC} -1.0	V _{CC} - 0.28		1
		V_{CC} = 2.3 to 3.6V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		GND	0.20	٧
		$V_{CC} = 2.3V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 6mA$		0.07	0.40	V
V_{OL}	LOW level output voltage	oltage $V_{CC} = 2.3V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 12\text{mA}$		0.15	0.70	
		$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 12mA$		0.14	0.40	٧
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 24mA$		0.27	0.55	1
Iį	Input leakage current	V_{CC} = 2.3 to 3.6V; V_{I} = V_{CC} or GND		0.1	5	μА
I _{OZ}	3-State output OFF-state current	V_{CC} = 2.3 to 3.6V; V_I = V_{IH} or V_{IL} ; V_O = V_{CC} or GND		0.1	10	μА
I _{CC}	Quiescent supply current	$V_{CC} = 2.3$ to 3.6V; $V_I = V_{CC}$ or GND; $I_O = 0$		0.2	40	μΑ
ΔI_{CC}	Additional quiescent supply current	$V_{CC} = 2.3V \text{ to } 3.6V; V_I = V_{CC} - 0.6V; I_O = 0$		150	750	μΑ
I _{BHL} ²	Bus hold LOW sustaining current	$V_{CC} = 2.3V; V_I = 0.7V$	45	-		μА
IBHL	Dus floid EOVV sustaining current	$V_{CC} = 3.0V; V_I = 0.8V$	75	150		μΛ
I _{BHH} ²	Bus hold HIGH sustaining current	V _{CC} = 2.3V; V _I = 1.7V	-45 -75	475		μΑ
	Due hold LOW evending a come of	$V_{CC} = 3.0V; V_{I} = 2.0V$	-75 500	–175		^
I _{BHLO} ²	Bus hold LOW overdrive current	$V_{CC} = 3.6V$	500			μΑ
I _{BHHO} ²	Bus hold HIGH overdrive current	V _{CC} = 3.6V	-500			L

All typical values are at T_{amb} = 25°C.
 Valid for data inputs of bus hold parts.

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AC CHARACTERISTICS FOR $V_{CC} = 2.3V$ TO 2.7V RANGE

 $GND = 0V; \ t_r = t_f \leq 2.0ns; \ C_L = 30pF$

				LIMITS		
SYMBOL	PARAMETER	WAVEFORM	V	UNIT		
			MIN	TYP ¹	MAX	1
t _{PHL} /t _{PLH}	Propagation delay nAn to nYn	1, 3	1.0	2.0	4.1	ns
t _{PZH} /t _{PZL}	3-State output enable time nOEn to nYn	2, 3	1.0	2.9	6.0	ns
t _{PHZ} /t _{PLZ}	3-State output disable time nOEn to nYn	2,3	1.2	2.1	5.6	ns

NOTE:

AC CHARACTERISTICS FOR $V_{CC} = 3.0 \text{V}$ TO 3.6V RANGE AND $V_{CC} = 2.7 \text{V}$

 $GND = 0V; \ t_r = t_f \le 2.5 ns; \ C_L = 50 pF$

				LIMITS					
SYMBOL	PARAMETER	WAVEFORM	WAVEFORM $V_{CC} = 3.3 \pm 0.3 V$				UNIT		
			MIN	TYP ^{1, 2}	MAX	MIN	TYP ¹	MAX	
t _{PHL} /t _{PLH}	Propagation delay nAn to nYn	1, 3	1.0	2.0	3.4	1.0	2.1	3.9	ns
t _{PZH} /t _{PZL}	3-State output enable time nOEn to nYn	2, 3	1.0	2.5	4.7	1.0	3.0	5.7	ns
t _{PHZ} /t _{PLZ}	3-State output disable time nOEn to nYn	2, 3	1.3	2.8	4.5	1.3	3.1	4.9	ns

^{1.} All typical values are at V_{CC} = 2.5V and T_{amb} = 25°C.

^{1.} All typical values are at V_{CC} T_{amb} = 25°C. 2. Typical value is measured at V_{CC} = 3.3V.

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AC WAVEFORMS FOR $V_{CC} = 2.3V$ TO 2.7V AND V_{CC} < 2.3V RANGE

 $V_{M} = 0.5 V$

 $V_X = V_{OL} + 0.15V$

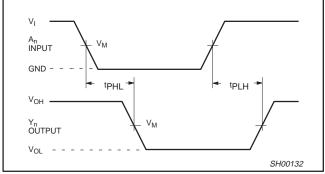
 $V_{Y} = V_{OH} - 0.15V$

V_{OL} and V_{OH} are the typical output voltage drop that occur with the

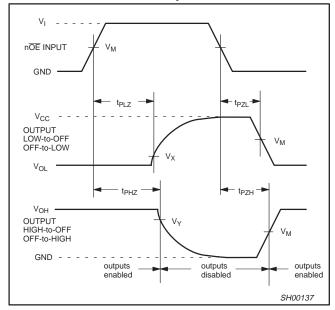
AC WAVEFORMS FOR $V_{CC} = 3.0V$ TO 3.6V AND $V_{CC} = 2.7V RANGE$

 V_M = 1.5 V V_X = V_{OL} + 0.3V V_Y = V_{OH} -0.3V V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load. $V_1 = 2.7V$

' = V_{CC}

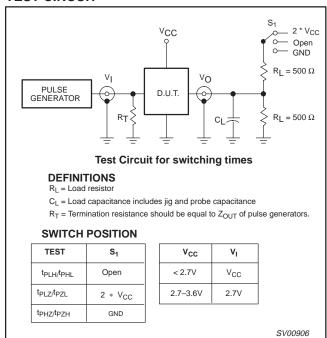


Waveform 1. The Input (nAx) to Output (nYx) Propagation **Delays**



Waveform 2. The 3-State Output Enable and Disable Times

TEST CIRCUIT



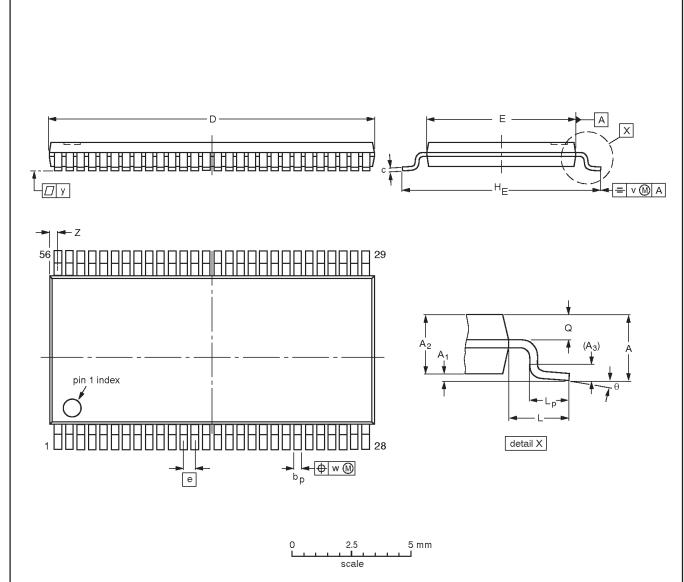
Waveform 3. Load circuitry for switching times

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TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1mm

SOT364-1



DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A ₁	A ₂	А3	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	٧	w	у	z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1.0	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

				EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE
SOT364-1		MO-153EE			€	-93-02-03 95-02-10

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NOTES

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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